

# MEMS Engineer Forum 2026

SMART Society Driven by MEMS

April 21-22, 2026

KFC Hall, Ryogoku, Tokyo, Japan

Free charge for conference and exhibition

## SPONSORSHIP Guidance

<http://www.m-e-f.info/>



Sponsors Type and Benefit (10% tax to be added)		GOLD	SILVER	BRONZE	Reception
		¥400,000	¥250,000	¥150,000	¥300,000
1	Advertisement for digital MEF Program Handout	A4 full size○	A4 full size○	A4 full size○	A4 full size○
2	Logo on MEF Website	○	○	○	○
3	Logo on MEF Sign board	○	○	○	○
4	1-min PR Movie Run at breaktime (main hall)	○	○	○	○
5	Invitation ticket(s) to Networking event (Apr. 16)	2*	1*	×	2*
6	Sp1-min PR Movie Run	○ (prior to one keynote speech)	×	×	○ (at the beginning of reception)
7	Lunch ticket(s) (Apr.16&17)	3*	2*	1*	3*
8	Meeting room usage	○	○	○	○
9	Registration List (limited only accepted)	○	○	×	○

\*If you apply by January 31, 2026, you will get double benefit for the columns with \*.

## Speakers for MEF 2026

By alphabetical order of last name

Palvi Apilo, TactoTek, Finland  
 Pierre Damien Berger, CEA LETI, France  
 Matthijn Dekkers, Lam Research, USA  
 Stefan Ernst, Xfab, Germany  
 Weiliun Fang, National Tsing Hua University, Taiwan  
 Tino Fuchs, Robert Bosch GmbH, Germany  
 Suryaprakash Ganti, Frore Systems, USA  
 Kazuyuki Higashi, NuFlare Technology, Inc., Japan  
 Shigeto Iwai, Yokogawa Electric Corp., Japan  
 Jerome Mouly, Yole Group, France  
 Hiroshi Suzuki, Syntiant Japan K.K., Japan  
 Mika Takahashi, IDtechEx, U.K.  
 Patrick Turner, Resonant Inc., a Murata Company, USA  
 Yao Zhu, Agency for Science, Technology and Research (A\*STAR), Singapore  
 TBA, QST Corporation Limited, China

More speakers are coming.....

## EXHIBIT Booth

All sponsors can enjoy discount exhibit price at additional 250,000 yen for regular booth. (50,000 yen discount).

Regular Booth Spec ¥300,000 (10% tax to be added)

Booth size: W1800mm × D900mm × H2100mm  
 (Height of table: 700mm)

The following items are included in the booth.

- Back panel
- Affiliation Name Board (standardized design)
- Electric outlet 500W (2 outlets)
- Chair

Academic Booth ¥60,000 (10% tax to be added)

Start-up Booth ¥60,000 (10% tax to be added)

The size of academic and start-up will be smaller.

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